

Product Change Notification - GBNG-27ULJU095

Date:

29 Aug 2019

Product Category:

Memory

Affected CPNs:



Notification subject:

CCB 3864 Final Notice: Qualification of MMT as a new assembly site for selected Atmel Parallel EEPROM products of the 19.1K and 19.5K wafer technologies available in 28L (13.6x15.1x2.57mm) and 30L (13.6x16x2.57mm) CPGA packages.

Notification text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of MMT as a new assembly site for selected Atmel Parallel EEPROM products of the 19.1K and 19.5K wafer technologies available in 28L (13.6x15.1x2.57mm) and 30L (13.6x16x2.57mm) CPGA packages.

Pre Change:

Assembled at ANAP assembly site.

Post Change:

Assembled at MMT assembly site.

Pre and Post Change Summary:

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	Pre Change	Post Change								
Assembly Site	Amkor Technology Philippine (P1/P2), INC. (ANAP)	Microchip Technology Thailand (Branch) / MMT								
Wire material	Al	Al								
Die attach material	JM7000	JM7000								
Lead frame material	Ceramic Alloy	Ceramic Alloy								

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve on-time delivery performance by qualifying MMT as a new assembly site. ANAP will no longer have manufacturing support to process selected Atmel Parallel EEPROM products available in 28L and 30L CPGA packages.

Change Implementation Status:

In Progress

Estimated First Ship Date:

September 29, 2019 (date code: 1940)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:



	August 2019				September 2019					
Workweek	31	32	33	34	35	36	37	38	39	40
Final PCN Issue Date					Χ					
Qual Report Availability					Χ					
Estimated Implementation Date										Х

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

August 29, 2019: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on September 29, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_GBNG-27ULJU095_Qual_Report.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

AT28C010-12UM/883

AT28C010-15UM/883

AT28C010-20UM/883

AT28C010E-12UM/883

AT28C256-15UM/883

AT28C256-15UM/883-610

AT28C256-15UM/883-815

AT28C256-20UM/883

AT28C256-20UM/883-815

AT28C256-25UM/883

AT28C256-25UM/883-815

AT28C256E-15UM/883

AT28C256E-15UM/883-815

AT28C256E-20UM/883

AT28C256E-25UM/883

AT28C256E-25UM/883-815

AT28C256F-15UM/883

AT28HC256-12UM/883

AT28HC256-90UM/883

AT28HC256E-12UM/883

AT28HC256E-90UM/883

AT28HC256F-12UM/883

AT28HC256F-90UM/883

Date: Wednesday, August 28, 2019